

## **General Description**

The MAX8586 single current-limited switch controls up to 1.2A to power USB applications and has multiple protection features including thermal shutdown, internal current limiting, and reverse current protection. The thermal shutdown limits junction temperature during a prolonged short or overload condition. The internal current-limiting circuitry protects the input supply against overload and is programmable using an external resistor. The MAX8586 meets all IEC specifications for USB ports.

The IC latches off when the output experiences a short circuit for more than 20ms, saving system power. Autorestart tests the shorted output with a 25mA current to determine if the short still exists. Once the short is removed, the MAX8586 automatically restarts the output. An open-drain fault signal notifies the system that the internal current limit has been reached. A 20ms fault-blanking feature allows the circuit to ignore momentary faults such as those caused when hotswapping into a capacitive load. An ENRESET input is available to disable the auto-restart function.

The MAX8586 features a SEL input that programs ON to be either active high or active low. The IC is supplied in a space-saving, 8-pin, 3mm x 3mm TDFN package.

PART	TEMP RANGE	PIN- PACKAGE	TOP MARK
MAX8586ETA	-40°C to +85°C	8 TDFN 3mm x 3mm (T833-2)	AMH
MAX8586ETA+	-40°C to +85°C	8 TDFN 3mm x 3mm (T833-2)	AMH
MAX8586ETA+T	-40°C to +85°C	8 TDFN 3mm x 3mm (T833-2)	AMH
MAX8586ETA/V+	-40°C to +85°C	8 TDFN 3mm x 3mm (T833-2)	BLU

**Ordering Information** 

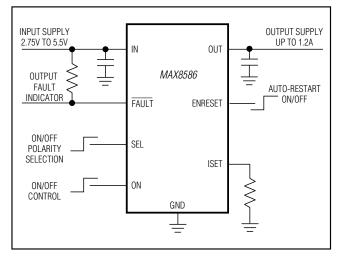
### Features

- ♦ Reverse Current Protection
- Programmable Current Limit Up to 1.2A
- Accurate Current Limit
- ♦ Selectable Auto-Restart when Fault Is Removed
- Thermal-Overload Protection
- Selectable Active-High/Low ON Input
- Built-In 20ms Fault Blanking
- Compliant with All USB Specifications
- ♦ 2.75V to 5.5V Input Supply Range
- ◆ FAULT Indicator Output
- ♦ 15kV ESD Protection (with Caps)
- Tiny 8-Pin 3mm x 3mm TDFN Package

### **Applications**

USB Ports/Hubs Desktop/Notebook Computers PDAs and Palmtop Computers Docking Stations

## **Typical Operating Circuit**



N denotes an automotive qualified part.

+Denotes a lead(Pb)-free/RoHS-compliant package.

T = Tape and reel.

Pin Configuration appears at end of data sheet.

# **MAX8586**

# Single 1.2A USB Switch in 3mm x 3mm TDFN

#### **ABSOLUTE MAXIMUM RATINGS**

IN, ON, SEL, OUT, FAULT, ISET, ENRESET to GND 0.3V to +6V
IN to OUT6V to +6V
FAULT Sink Current
Continuous Power Dissipation
8-Pin 3mm x 3mm TDFN
(derate 24mW/°C above +70°C)1951mW

Operating Temperature Range	40°C to +85°C
Junction Temperature	+150°C
Storage Temperature Range	65°C to +150°C
Soldering Temperature (reflow)	+260°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **ELECTRICAL CHARACTERISTICS**

 $(V_{IN} = V_{ON} = V_{SEL} = V_{ENRESET} = 5V, R_{ISET} = 26k\Omega$  to GND,  $R_{FAULT} = 100k\Omega$  pullup to  $V_{IN}$ ,  $C_{OUT} = 0.1\mu$ F,  $T_A = -40^{\circ}$ C to +85°C. Typical values are at  $T_A = +25^{\circ}$ C, unless otherwise specified.) (Note 1)

PARAMETER	CONDIT	IONS	MIN	ТҮР	MAX	UNITS	
Supply Voltage Range		2.75		5.50	V		
	$V_{IN} = 5V$		55				
Switch On-Resistance	$V_{IN} = 3V$	V <sub>IN</sub> = 3V				mΩ	
	$V_{IN} = 4.4V$				95		
IN Standby Supply Current	$V_{ON} = 0V$			3	6	μA	
IN Quiescent Supply Current	I <sub>OUT</sub> = 0A			30	55	μA	
		$T_A = +25^{\circ}C$		0.02	1		
OUT Off-Leakage Current	$V_{ON} = 0V, V_{OUT} = 0V$	T <sub>A</sub> = +85°C		0.6		μA	
Undervoltage-Lockout Threshold	Rising edge, 3% hystere	2.3	2.5	2.7	V		
Current-Limit Threshold	$R_{ISET} = 26k\Omega$		1.2	1.4	1.6		
	$R_{ISET} = 39k\Omega$	0.800	0.925	1.050	А		
	$R_{ISET} = 60k\Omega$		0.5	0.6	0.7		
		$R_{ISET} = 26k\Omega$	1.35	1.75	2.20	A (Peak)	
Peak Short-Circuit Current Limit	$V_{OUT} = 0V,$ (I_OUT pulsing)	$R_{ISET} = 39k\Omega$		1.2			
	(IOUT puising)	$R_{ISET} = 60k\Omega$		0.74			
		$R_{ISET} = 26k\Omega$		0.55			
RMS Short-Circuit Current Limit	$V_{OUT} = 0V,$ (I <sub>OUT</sub> pulsing)	$R_{ISET} = 39k\Omega$		0.37		A (RMS)	
	(IOUT puising)		0.23		1		
Short-Circuit/Continuous Current Limit Transition Threshold	(Note 2)			1		V	
Fault-Blanking Timeout Period	From current-limit condi	tion to FAULT falling	8	20	40	ms	

## **MAX8586**

# Single 1.2A USB Switch in 3mm x 3mm TDFN

#### **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{IN} = V_{ON} = V_{SEL} = V_{ENRESET} = 5V, R_{ISET} = 26k\Omega$  to GND,  $R_{FAULT} = 100k\Omega$  pullup to  $V_{IN}$ ,  $C_{OUT} = 0.1\mu$ F,  $T_A = -40^{\circ}$ C to  $+85^{\circ}$ C. Typical values are at  $T_A = +25^{\circ}$ C, unless otherwise specified.) (Note 1)

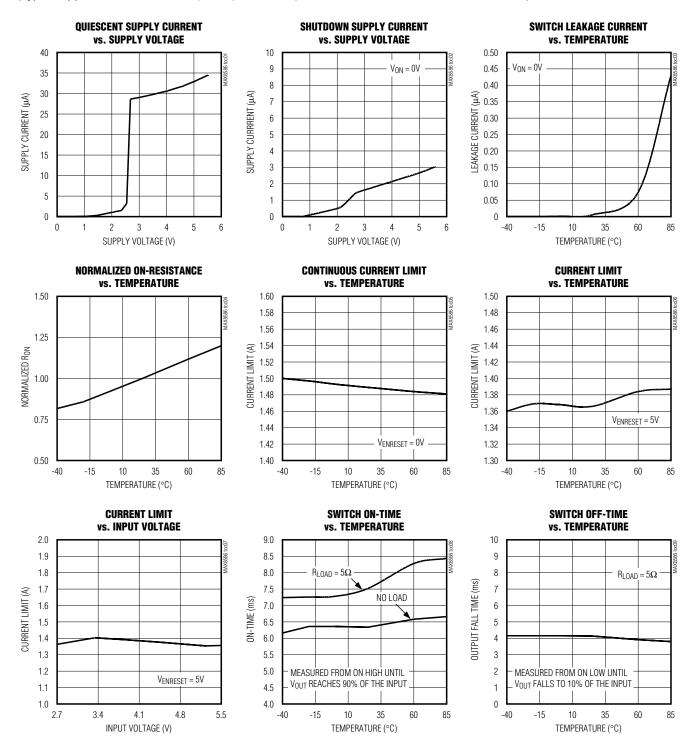
PARAMETER	CONDITIONS	MIN	ТҮР	MAX	UNITS
Turn-On Delay	$R_{OUT} = 10\Omega$ , $C_{OUT} = 1\mu$ F, measured from ON rising to 10% of V <sub>OUT</sub> , does not include rise time	0.5	1.5	4.0	ms
Output Rise Time	$R_{OUT}$ = 10 $\Omega,$ $C_{OUT}$ = 1 $\mu F,$ measured from 10% to 90% of $V_{OUT}$		5.5		ms
Turn-Off Delay from ON	$R_{OUT}$ = 10 $\Omega$ , $C_{OUT}$ = 1 $\mu$ F measured from ON falling to 90% of V <sub>OUT</sub>		100	1000	μs
Output Fall Time	$R_{OUT}$ = 10 $\Omega$ , $C_{OUT}$ = 1 $\mu$ F, measured from 90% to 10% of V <sub>OUT</sub>		4		ms
Thermal-Shutdown Threshold	15°C hysteresis (typ)		+160		°C
ON, SEL, ENRESET Logic Input High Voltage	V <sub>IN</sub> = 2.75V to 4.0V	1.6			v
ON, SEL, ENRESET LOGIC INput High Voltage	$V_{IN} = 4.0V \text{ to } 5.5V$	2.0			v
ON, SEL, ENRESET Logic Input Low Voltage	V <sub>IN</sub> = 2.75V to 4.0V			0.6	V
ON, SEL, ENRESET LOGIC INput Low Voltage	$V_{IN} = 4.0V \text{ to } 5.5V$			0.8	v
Logic Input Current	$T_A = +25^{\circ}C$	-1		+1	μΑ
FAULT Output Low Voltage	I <sub>SINK</sub> = 1mA			0.4	V
FAULT Output High Leakage Current	$V_{IN} = 5.5V, T_A = +25^{\circ}C$			1	μΑ
ISET Current-Limit Trip Point	$R_{ISET} = 26k\Omega$		600		mV
ISET External Resistance Range		26		60	kΩ
Auto-Restart Current	In latched-off state, $V_{OUT} = 0V$	10	25	60	mA
Auto-Restart Threshold	In latched-off state, VOUT rising	0.4	0.5	0.6	V
Auto-Restart Delay	In latched-off state, V <sub>OUT</sub> >1V	8	20	40	ms

Note 1: All devices are 100% production tested at T<sub>A</sub> = +25°C. Limits over the operating temperature range are guaranteed by design.

Note 2: The output voltage at which the device transitions from short-circuit current limit to continuous current limit.

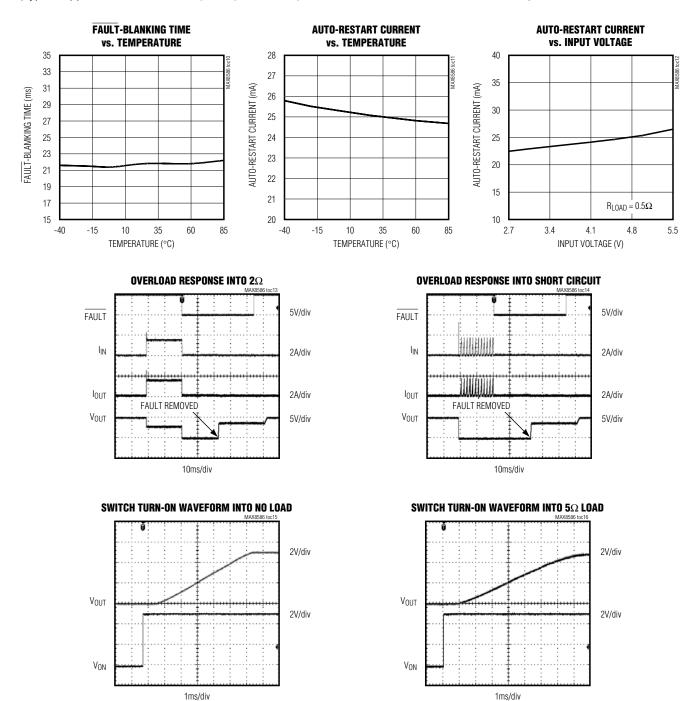
### **Typical Operating Characteristics**

(Typical Application Circuit, VIN = VON = VSEL = VENRESET = 5V, TA = +25°C, unless otherwise noted.)



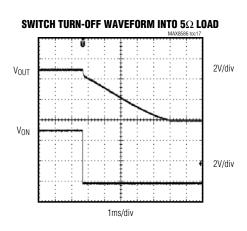
### Typical Operating Characteristics (continued)

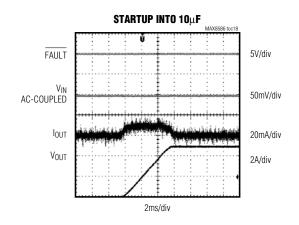
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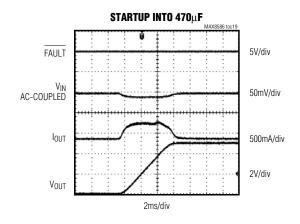


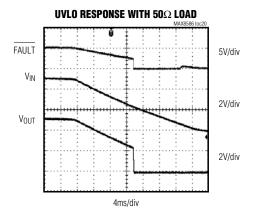
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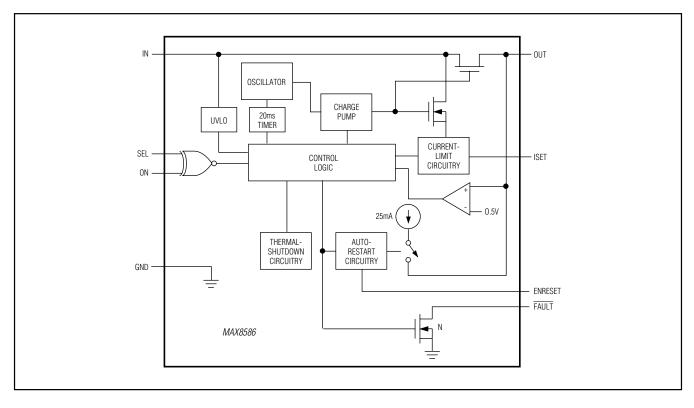






### **Pin Description**

PIN	NAME	FUNCTION
1	SEL	ON Polarity Selector Input. Drive SEL high to select ON for an active-high enable. Drive SEL to GND to select ON for an active-low enable.
2	ISET	Current-Limit Programming Input. Connect a resistor from ISET to GND to set the internal current limit. The valid range for $R_{ISET}$ is 26k $\Omega$ to 60k $\Omega$ .
3	ON	Enable Input. Drive ON high to enable the device when SEL is high. Drive ON low to enable the device when SEL is low.
4	IN	Power-Supply Input. Connect to an input power supply in the 2.75V to 5.5V range. Bypass IN to GND with a 1µF or greater ceramic capacitor.
5	OUT	Power Output. Bypass OUT to GND with a $1\mu$ F or greater capacitor. OUT is high impedance during shutdown.
6	FAULT	Open-Drain Fault-Indicator Output. FAULT is low when the input is below UVLO, or during current limit, reverse current detection, or thermal shutdown.
7	GND	Ground. Connect GND to the exposed paddle and to a ground plane.
8	ENRESET	Auto-Restart Enable Input. Drive ENRESET high to enable auto-restart mode. Drive ENRESET low to disable auto-restart mode.
	EP	Exposed Pad. Connect the exposed pad to a large ground plane to improve thermal power dissipation.



## Functional Diagram

### **Detailed Description**

#### **Current-Limit Protection**

The MAX8586 uses two methods to protect the circuit from overcurrent conditions. Continuous current limiting has tighter accuracy but slower response time compared to short-circuit limiting. Combining both methods provides a high degree of protection for a variety of faults. When a current-limit fault occurs with VOUT greater than 1V, the device operates in continuous current-limit mode and limits output current to a user-programmable level. When VOUT is less than 1V, the device operates in short-circuit current-limit mode and pulses the output current to levels that are 30% (typ) higher than the selected continuous current limit.

When either fault condition persists for 20ms (typ), the fault flag is asserted. With the auto-restart enabled (ENRESET high) the output also latches off and is tested with a 25mA current to detect when the fault condition has been removed. 20ms after the fault condition is removed, the output automatically restarts. With the auto-restart disabled (ENRESET low), the output continues to source the current-limit current as long as the fault is present.

#### **Reverse Current Protection**

The USB specification does not allow an output device to source current back into the USB port. However, the MAX8586 is designed to safely power noncompliant devices. During normal operation with the channel enabled, if the current from the output to the input exceeds 1A (typ) for more than 20ms (typ), the IC turns off the switch and the FAULT flag is asserted. When the IC is disabled, the output is switched to a high-impedance state, blocking reverse current flow from the output back to the input.

#### **On/Off Control and UVLO**

The MAX8586 has a selectable active-high/low ON polarity. Drive SEL high to select an active-high for ON; drive SEL low to select active-low for ON. The MAX8586 includes a UVLO circuit to prevent erroneous switch operation when the input voltage goes low during startup and brownout conditions. Input voltages of less than +2.5V (typ) inhibit operation of the device. FAULT asserts low during a UVLO condition.

**Output Fault Protection and Auto-Restart** The MAX8586 uses an auto-restart function to detect short-circuit removal by sourcing 25mA from the output and monitoring the output voltage. When the voltage at the output exceeds 0.5V for 20ms, the fault flag releases, the output turns back on, and the 25mA current source turns off. Active loads are not expected to draw measurable current when supplied with less than 0.5V. The autorestart function is enabled when ENRESET is high. Drive ENRESET low to disable the auto-restart function. When the auto-restart function is disabled, OUT regulates the current to the programmed current limit.

#### Fault Indicator and Fault Blanking

The MAX8586 provides an open-drain output (FAULT) to signal fault conditions. Connect FAULT to IN through a 100k $\Omega$  pullup resistor for most applications. FAULT asserts low when any of the following conditions occur:

- The input voltage is below the UVLO threshold.
- The switch junction temperature exceeds the +160°C thermal-shutdown temperature limit.
- The switch is in current-limit or short-circuit currentlimit mode for longer than the fault-blanking period (20ms typ).
- The reverse current exceeds the 1A threshold for longer than the fault-blanking period (20ms typ).

When auto-restart is enabled, the FAULT output goes high impedance after a 20ms delay once the fault condition is removed. With auto-restart disabled, during the fault the output is tested every 20ms. When the fault is removed, the FAULT output goes high impedance after a delay that can be up to 20ms. Ensure that the MAX8586 input bypass capacitance prevents glitches from triggering the FAULT output. To distinguish large capacitive loads from short circuits or sustained overloads, the MAX8586 has a fault-blanking circuit. When a load transient causes the output to enter current limit, an internal counter monitors the duration of the fault. For load faults exceeding the 20ms fault-blanking time, the switch turns off, FAULT asserts low, and the output enters auto-restart mode (see the Current-Limit Protection and Output Fault Protection and Auto-Restart sections). Only current-limit and short-circuit faults are blanked. Thermal-overload faults and input voltages below the UVLO threshold immediately turn the output off and assert FAULT low.

Fault blanking allows the MAX8586 to handle USB loads that might not be fully compliant with USB specifications. The MAX8586 successfully powers USB loads with additional bypass capacitance and/or large startup currents while protecting the upstream power source. No fault is reported if the switch brings up the load within the 20ms blanking period.

#### **Thermal Shutdown**

When the MAX8586 die temperature exceeds +160°C, the switch turns off and FAULT goes low. Thermal shutdown does not utilize the 20ms fault-blanking timeout period. When the junction temperature cools by 15°C, the switch turns on again and FAULT returns high. When an overload condition persists, the switch cycles on and off, resulting in a pulsed output that reduces the average system load.

#### **Applications Information**

#### **Setting the Current Limit**

A resistor from ISET to ground programs the currentlimit value. Use a resistor between  $26k\Omega$  and  $60k\Omega$  to set the current limit according to the formula:

ILIM(TYPICAL) = 36400 / RISET (Amps)

Do not use RISET values below  $26k\Omega$  because the maximum current rating of the device may be exceeded. RISET values larger than  $60k\Omega$  are not recommended and do not provide a lower limit current than 500mA. If the output drops below 1V (typ), the MAX8586 shifts to a short-circuit current-limit threshold that is 30% above the programmed level given by the ILIM(TYPICAL) formula.

#### **Input Power Supply and Capacitance**

To limit the input voltage drop during momentary output load transients, connect a capacitor from IN to ground. A 1 $\mu$ F ceramic capacitor is required for local decoupling; however, higher capacitor values further reduce the voltage drop at the input. When driving inductive loads, a larger capacitance may be needed to prevent voltage spikes from exceeding the MAX8586's absolute maximum ratings.

#### **Output Capacitance**

A capacitor as large as 500µF is allowed on the output to smooth out transients and/or increase rise/fall times. Larger output capacitance may be used, but the resulting output charge time during startup may exceed the fault-blanking period resulting in a FAULT flag.

#### **Driving Inductive Loads**

A wide variety of devices (mice, keyboards, cameras, and printers) typically connect to the USB port with cables, adding an inductive component to the load. This inductance causes the output voltage at the USB port to oscillate during a load step. The MAX8586 drives inductive loads; however, care must be taken to avoid exceeding the device's absolute maximum ratings. Usually, the load inductance is relatively small, and the MAX8586's input includes a substantial bulk capacitance from an upstream regulator as well as local bypass capacitors, limiting overshoot. If severe ringing occurs because of large load inductance, clamp the MAX8586 output below +6V and above -0.3V.

#### Turn-On and Turn-Off Behavior

The MAX8586 features a slow turn-on and turn-off, minimizing loading transients on the upstream power source. SEL sets the active polarity of the logic inputs of the MAX8586. Drive ON to the same logic state as SEL to enable the output. Drive ON to the opposite logic state as SEL to disable the output (see Table 1). The output enters a high-impedance state when disabled.

#### Table 1. SEL/ON Inputs

SEL	ON	OUT STATE
High	High	Enabled
High	Low	Disabled
Low	High	Disabled
Low	Low	Enabled

#### **Layout and Thermal Dissipation**

Keep all input/output traces as short as possible to reduce the effect of undesirable parasitic inductance and optimize the switch response time to output shortcircuit conditions. Place input and output capacitors no more than 5mm from device leads. Connect IN and OUT to the power bus with short traces. Wide power bus planes at IN and OUT provide superior heat dissipation as well. An active switch dissipates little power with minimal change in package temperature. Calculate the power dissipation for this condition as follows:

$$P = IOUT^2 \times RON$$

At the normal operating current ( $I_{OUT} = 0.5A$ ) and the maximum on-resistance of the switch (95m $\Omega$ ), the power dissipation is:

#### $P = (0.5A)^2 \times 0.95\Omega = 24mW$

The worst-case power dissipation occurs when the output current is just below the current-limit threshold with an output voltage greater than 1V. In this case, the power dissipated in the switch is the voltage drop across the switch multiplied by the current limit:

$$P = I_{LIM} \times (V_{IN} - V_{OUT})$$

For a 5.5V input and 1V output, the maximum power dissipation is:

$$P = 1.6A \times (5.5V - 1V) = 7.2W$$

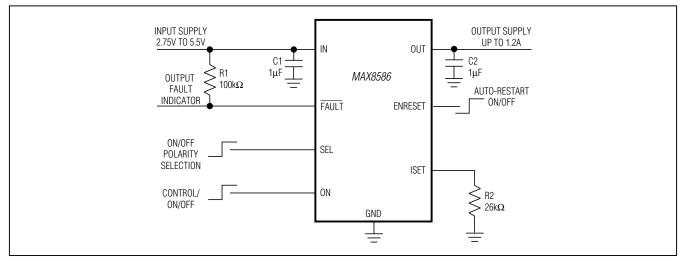


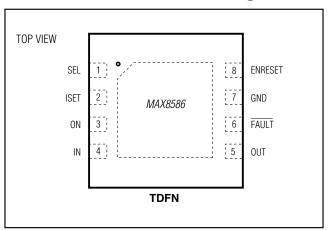
Figure 1. Typical Application Circuit

Because the package power dissipation is 1951mW, the MAX8586 die temperature exceeds the  $+160^{\circ}$ C thermal-shutdown threshold when dissipating 7.2W, and the switch output shuts down until the junction temperature cools by 15°C. The duty cycle and period are strong functions of the ambient temperature and the PC board layout (see the *Thermal Shutdown* section).

If the output current exceeds the current-limit threshold, or the output voltage is pulled below the short-circuit detect threshold, the MAX8586 enters a fault state after 20ms, at which point auto-restart mode is enabled and 25mA is sourced by the output to test for removal of the overload. For a 5V input, OUT short circuited to GND, and auto-restart mode active, the power dissipation is as follows:

$$P = 0.025A \times 5V = 0.125W$$

#### **Pin Configuration**



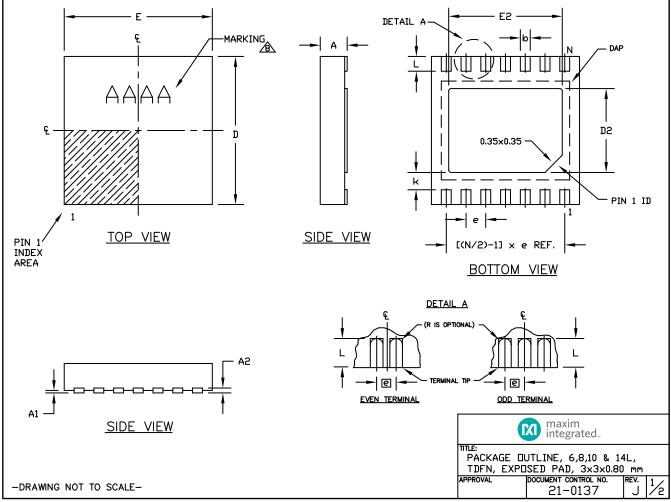
#### Chip Information

TRANSISTOR COUNT: 2117 PROCESS: BICMOS

### Package Information

For the latest package outline information and land patterns (footprints), go to <u>www.maximintegrated.com/packages</u>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	OUTLINE NO.	LAND PATTERN NO.
8 TQFN-EP	T833-2	<u>21-0137</u>	<u>90-0059</u>



## \_Package Information (continued)

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MIN. MAX.   0.70 0.80   2.90 3.10   2.90 3.10   0.00 0.05   0.20 0.40   0.25 MIN.   0.20 REF.	PKG. CODE T633-2 T833-2 T833-3 T1033-1 T1033-1 T1033-2 T1433-1 T1433-2 T1433-3F	N   6     8   8     10   10     10   14     14   14	D2 1.50±0.10 1.50±0.10 1.50±0.10 1.50±0.10 1.50±0.10 1.50±0.10 1.70±0.10 1.70±0.10	E2 2.30±0.10 2.30±0.10 2.30±0.10 2.30±0.10 2.30±0.10 2.30±0.10 2.30±0.10 2.30±0.10 2.30±0.10	e 0.95 BSC 0.65 BSC 0.50 BSC 0.50 BSC 0.50 BSC 0.50 BSC 0.40 BSC 0.40 BSC	JEDEC SPEC MO229 / WEEA MO229 / WEEC MO229 / WEED-3 MO229 / WEED-3 MO229 / WEED-3 	0.25±0.05	[(N/2)-1] x e 1.90 REF 1.95 REF 2.00 REF 2.00 REF 2.00 REF 2.40 REF 2.40 REF 2.40 REF
2.90 3.10 2.90 3.10 0.00 0.05 0.20 0.40 0.25 MIN. 0.20 REF.	T833-2   T833-3   T1033-1   T1033MK-1   T1033-2   T1433-1   T1433-2	8 8 10 10 10 14 14	1.50±0.10 1.50±0.10 1.50±0.10 1.50±0.10 1.50±0.10 1.70±0.10 1.70±0.10	2.30±0.10 2.30±0.10 2.30±0.10 2.30±0.10 2.30±0.10 2.30±0.10 2.30±0.10	0.65 BSC 0.65 BSC 0.50 BSC 0.50 BSC 0.50 BSC 0.50 BSC 0.40 BSC 0.40 BSC	MO229 / WEEC MO229 / WEED-3 MO229 / WEED-3 MO229 / WEED-3 MO229 / WEED-3 	0.30±0.05 0.30±0.05 0.25±0.05 0.25±0.05 0.25±0.05 0.20±0.05 0.20±0.05	1.95 REF 1.95 REF 2.00 REF 2.00 REF 2.00 REF 2.40 REF 2.40 REF
2.90 3.10 0.00 0.05 0.20 0.40 0.25 MIN. 0.20 REF.	T833-3 T1033-1 T1033MK-1 T1033-2 T1433-1 T1433-2	8 10 10 10 10 14 14	1.50±0.10 1.50±0.10 1.50±0.10 1.50±0.10 1.70±0.10 1.70±0.10	2.30±0.10 2.30±0.10 2.30±0.10 2.30±0.10 2.30±0.10 2.30±0.10	0.65 BSC 0.50 BSC 0.50 BSC 0.50 BSC 0.40 BSC 0.40 BSC	MO229 / WEEC MO229 / WEED-3 MO229 / WEED-3 MO229 / WEED-3 	0.30±0.05 0.25±0.05 0.25±0.05 0.25±0.05 0.20±0.05 0.20±0.05	1.95 REF 2.00 REF 2.00 REF 2.00 REF 2.40 REF 2.40 REF
0.00 0.05 0.20 0.40 0.25 MIN. 0.20 REF.	T1033-1 T1033MK-1 T1033-2 T1433-1 T1433-2	10 10 10 14 14	1.50±0.10 1.50±0.10 1.50±0.10 1.70±0.10 1.70±0.10	2.30±0.10 2.30±0.10 2.30±0.10 2.30±0.10 2.30±0.10	0.50 BSC 0.50 BSC 0.50 BSC 0.40 BSC 0.40 BSC	MO229 / WEED-3 MO229 / WEED-3 MO229 / WEED-3 	0.25±0.05 0.25±0.05 0.25±0.05 0.20±0.05 0.20±0.05	2.00 REF 2.00 REF 2.00 REF 2.40 REF 2.40 REF
0.20 0.40 0.25 MIN. 0.20 REF.	T1033MK-1 T1033-2 T1433-1 T1433-2	10 10 14 14	1.50±0.10 1.50±0.10 1.70±0.10 1.70±0.10	2.30±0.10 2.30±0.10 2.30±0.10 2.30±0.10	0.50 BSC 0.50 BSC 0.40 BSC 0.40 BSC	MO229 / WEED-3 MO229 / WEED-3	0.25±0.05 0.25±0.05 0.20±0.05 0.20±0.05	2.00 REF 2.00 REF 2.40 REF 2.40 REF
0.25 MIN. 0.20 REF.	T1033-2 T1433-1 T1433-2	10 14 14	1.50±0.10 1.70±0.10 1.70±0.10	2.30±0.10 2.30±0.10 2.30±0.10	0.50 BSC 0.40 BSC 0.40 BSC	MO229 / WEED-3	0.25±0.05 0.20±0.05 0.20±0.05	2.00 REF 2.40 REF 2.40 REF
0.20 REF.	T1433-1 T1433-2	14 14	1.70±0.10 1.70±0.10	2.30±0.10 2.30±0.10	0.40 BSC 0.40 BSC		0.20±0.05 0.20±0.05	2.40 REF 2.40 REF
	T1433-2	14	1.70±0.10	2.30±0.10	0.40 BSC		0.20±0.05	2.40 REF
	T1433-3F	14	1.70±0.10	2.30±0.10	0.40 BSC		0.20±0.05	2.40 REF
							1	
ARITY SHALL N E SHALL NOT E LENGTH/PAC G CONFORMS THE TOTAL NU R OF LEADS SH G IS FOR PACH	IUMBER OF LEADS. SHOWN ARE FOR REF CKAGE ORIENTATION F	ONSID EXCEP ERENO REFERI	ERED AS S T DIMENSIO CE ONLY. ENCE ONLY	NS "D2" AN	ND "E2", AN		1433–2.	
IENSIONS APPL	LT TO BOTH LEADED	(-)	AND POFKE	E (+) FKG	. CODES.		OUTLINE,	egrated 6,8,10 & 14L,
THE R O G I:	E TOTAL N IF LEADS S FOR PA	E TOTAL NUMBER OF LEADS. IF LEADS SHOWN ARE FOR REF S FOR PACKAGE ORIENTATION F SIONS APPLY TO BOTH LEADED	E TOTAL NUMBER OF LEADS. IF LEADS SHOWN ARE FOR REFEREN S FOR PACKAGE ORIENTATION REFER SIONS APPLY TO BOTH LEADED (-)	E TOTAL NUMBER OF LEADS. IF LEADS SHOWN ARE FOR REFERENCE ONLY. IS FOR PACKAGE ORIENTATION REFERENCE ONLY SIONS APPLY TO BOTH LEADED (-) AND PbFRE	E TOTAL NUMBER OF LEADS. IF LEADS SHOWN ARE FOR REFERENCE ONLY. IS FOR PACKAGE ORIENTATION REFERENCE ONLY. SIONS APPLY TO BOTH LEADED (-) AND PEFREE (+) PKG	E TOTAL NUMBER OF LEADS. IF LEADS SHOWN ARE FOR REFERENCE ONLY. IS FOR PACKAGE ORIENTATION REFERENCE ONLY. SIONS APPLY TO BOTH LEADED (-) AND PEREE (+) PKG. CODES.	E TOTAL NUMBER OF LEADS. IF LEADS SHOWN ARE FOR REFERENCE ONLY. S FOR PACKAGE ORIENTATION REFERENCE ONLY. SIONS APPLY TO BOTH LEADED (-) AND PbFREE (+) PKG. CODES. TITLE: PACKAGE	IF LEADS SHOWN ARE FOR REFERENCE ONLY. S FOR PACKAGE ORIENTATION REFERENCE ONLY. SIONS APPLY TO BOTH LEADED (-) AND PbFREE (+) PKG. CODES. TITLE: PACKAGE DUTLINE, TDFN, EXPOSED PA APPROVAL DOCUMENT

# **MAX8586**

# Single 1.2A USB Switch in 3mm x 3mm TDFN

### **Revision History**

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	11/04	Initial release	—
1	1/09	Added automotive part number	1
2	1/10	Removed UL Listing Pending note, corrected top mark for automotive part, and added soldering temperature (reflow)	1, 2
3	1/13	Added lead-free designation	1



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